MRF3866

The RF Line
NPN Silicon High-Frequency Transistor

. . . designed for amplifier and oscillator applications in industrial equipment construted with surface mount components.

- Low Cost SORF Plastic Surface Mount Package
- Guaranteed RF Specification — $|S_{21}|^2$
- S-Parameter Characterization
- Tape and Reel Packaging Options Available

SURFACE MOUNT
RF TRANSISTOR
NPN SILICON

CASE 751, STYLE 1
(SO-8)

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MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	30	V
Collector-Base Voltage	V_{CBO}	55	V
Emitter-Base Voltage	V_{EBO}	3.5	V
Collector Current — Continuous	I_C	0.4	A
Total Device Dissipation @ T_A = 25°C Derate above 25°C	P_D	1.0 8.0	Watt mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Storage Temperature	T_{stg}	150	°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	125	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage (I_C = 5.0 mA, R_{BE} = 10 Ω)	$V_{(BR)CER}$	55	—	—	V
Collector-Base Sustaining Voltage (I_E = 5.0 mA)	$V_{CEO(sus)}$	30	—	—	V
Collector-Base Breakdown Voltage (I_C = 0.1 mA)	$V_{(BR)CBO}$	55	—	—	V
Emitter-Base Breakdown Voltage (I_E = 0.1 mA)	$V_{(BR)EBO}$	3.5	—	—	V
Collector Cutoff Current (V_{CE} = 28 V)	I_{CEO}	—	—	20	μA
Collector Cutoff Current (V_{CE} = 55 V, V_{BE} = −1.5 V Reverse)	I_{CEX}	—	—	100	μA
ON CHARACTERISTICS					
DC Current Gain (I_C = 0.36 A, V_{CE} = 5.0 V) (I_C = 0.05 A, V_{CE} = 5.0 V)	h_{FE}	 5.0 10	 — —	 — 200	—
Collector-Emitter Saturation Voltage (I_C = 100 mA, I_B = 20 mA)	$V_{CE(sat)}$	—	—	1.0	V
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain — Bandwidth Product (I_C = 50 mA, V_{CE} = 15 V, f = 200 MHz)	f_T	500	800	—	MHz
Output Capacitance (V_{CB} = 30 V, f = 1.0 MHz)	C_{obo}	—	—	3.0	pF

V_{CE} (Volts)	I_C (mA)	f (MHz)	S_{11}		S_{21}		S_{12}		S_{22}	
			S_{11}	∠ϕ	S_{21}	∠ϕ	S_{12}	∠ϕ	S_{22}	∠ϕ
15	50	100	0.67	−166	13.75	92	0.016	44	0.32	−27
		200	0.69	−176	6.93	81	0.024	53	0.30	−24
		300	0.70	177	4.57	73	0.032	57	0.32	−31
		400	0.71	172	3.38	67	0.042	59	0.34	−37
		500	0.72	168	2.66	61	0.049	59	0.37	−45
		600	0.72	164	2.17	54	0.056	61	0.40	−53
		700	0.72	160	1.85	49	0.061	63	0.43	−60
		800	0.72	155	1.61	44	0.068	65	0.47	−66
		900	0.71	151	1.40	39	0.075	64	0.50	−73
		1000	0.70	146	1.25	34	0.084	68	0.53	−79

Table 1. Common Emitter S-Parameters

MRF4427

The RF Line
NPN Silicon
RF Low Power Transistor

. . . designed for amplifier, frequency multiplier, or oscillator applications in industrial equipment constructed with surface mount components. Suitable for use as output driver or pre-driver stages in VHF and UHF equipment.

- Low Cost SORF Plastic Surface Mount Package
- Guaranteed RF Specification — $|S_{21}|^2$
- S-Parameter Characterization
- Low Voltage Version of MRF3866
- Tape and Reel Packaging Options Available

1.0 W, 175 MHz
HIGH-FREQUENCY
TRANSISTOR
NPN SILICON

CASE 751, STYLE 1
SORF
(SO-8)

2

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	20	Vdc
Collector-Base Voltage	V_{CBO}	40	Vdc
Emitter-Base Voltage	V_{EBO}	2.0	Vdc
Collector Current — Continuous	I_C	400	mAdc
Total Device Dissipation @ T_A = 25°C Derate above 25°C	P_D	1.5 12.5	Watts mW/°C
Operating Junction and Storage Temperature Range	T_J, T_{stg}	−65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	125	°C/W

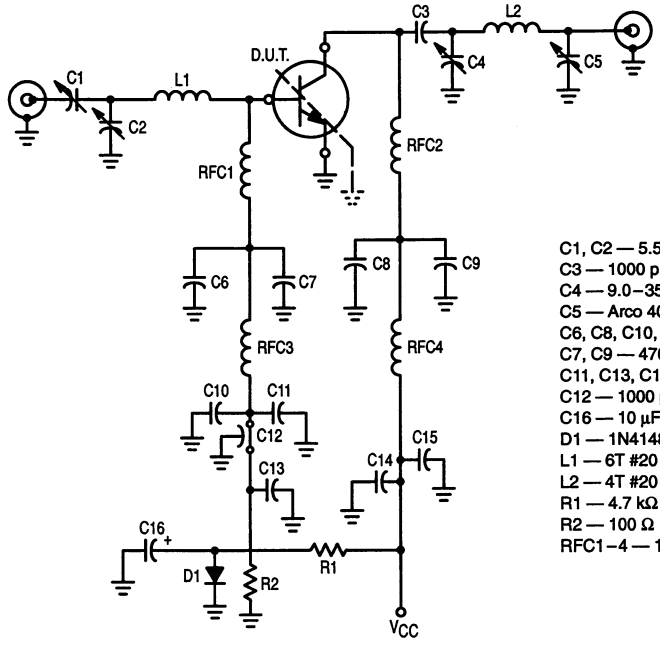
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Sustaining Voltage (I_C = 5.0 mAdc, I_B = 0)	$V_{(BR)CEO}$	20	—	—	Vdc
Collector-Emitter Breakdown Voltage (I_C = 5.0 mAdc, R_{BE} = 10 ohms)	$V_{(BR)CER}$	40	—	—	Vdc
Emitter-Base Breakdown Voltage (I_E = 100 μAdc)	$V_{(BR)EBO}$	2.0	—	—	Vdc
Collector Cutoff Current (V_{CE} = 12 Vdc, I_B = 0)	I_{CEO}	—	—	20	μAdc

(continued)

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (I_C = 100 mAdc, V_{CE} = 5.0 Vdc) (I_C = 360 mAdc, V_{CE} = 5.0 Vdc)	h_{FE}	 10 5.0	 50 —	 200 —	—
Collector-Emitter Saturation Voltage (I_C = 100 mAdc, I_B = 20 mAdc)	$V_{CE(sat)}$	—	60	—	mVdc
DYNAMIC CHARACTERISTICS					
Current-Gain — Bandwidth Product (I_C = 50 mAdc, V_{CE} = 12 Vdc, f = 200 MHz)	f_T	—	1600	—	MHz
Output Capacitance (V_{CB} = 12 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	—	3.0	pF
FUNCTIONAL TESTS					
Common-Emitter Amplifier Power Gain (P_{in} = 15 mW, V_{CC} = 12 Vdc, f = 175 MHz)	G_{pe}	—	18	—	dB
Collector Efficiency (Figure 1) (P_{out} = 1.0 W, V_{CC} = 12 Vdc, f = 175 MHz)	η	—	60	—	%
Insertion Gain (V_{CE} = 12 Vdc, I_C = 50 mA, f = 200 MHz)	$\lvert S_{21}\rvert^2$	14	16.4	—	dB



C1, C2 — 5.5–18 pF Erie ceramic trimmer
C3 — 1000 pF ATC 100 mil chip cap.
C4 — 9.0–35 pF Erie ceramic trimmer
C5 — Arco 405 mica trimmer
C6, C8, C10, C14 — 0.1 µF Erie blue cap.
C7, C9 — 470 pF ATC 100 mil chip cap.
C11, C13, C15 — 1.0 µF Erie blue cap, non-polar
C12 — 1000 pF feedthru
C16 — 10 µF, 25 V tantalum
D1 — 1N4148 or 1N914
L1 — 6T #20 AWG on #2 drill bit
L2 — 4T #20 AWG on #4 drill bit
R1 — 4.7 kΩ 1/8 watt carbon
R2 — 100 Ω 1/8 watt carbon
RFC1–4 — 10 µH molded choke

Figure 1. 175 MHz RF Amplifier Circuit for Functional Tests

TYPICAL CHARACTERISTICS

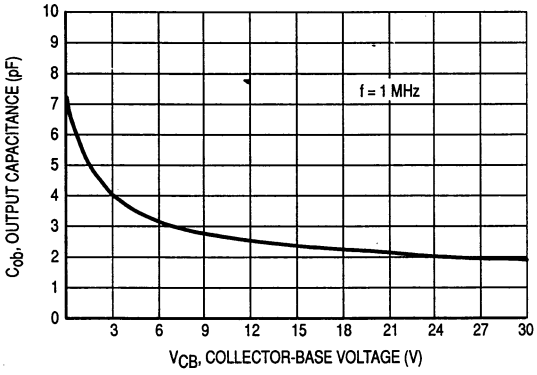


Figure 2. Collector-Base Capacitance versus Voltage

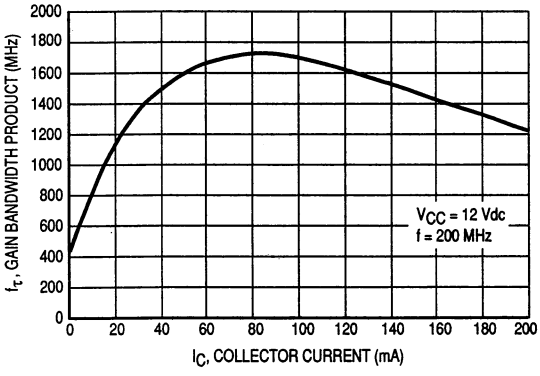


Figure 3. Gain Bandwidth Product versus Collector Current

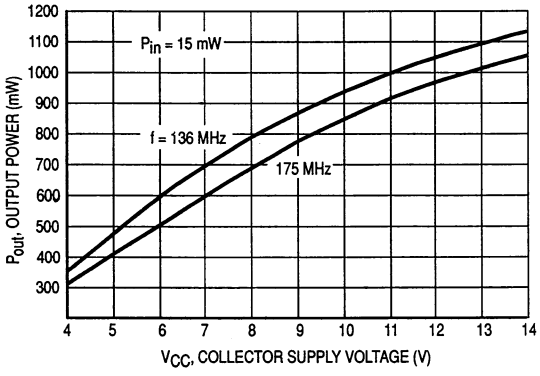


Figure 4. Output Power versus Voltage

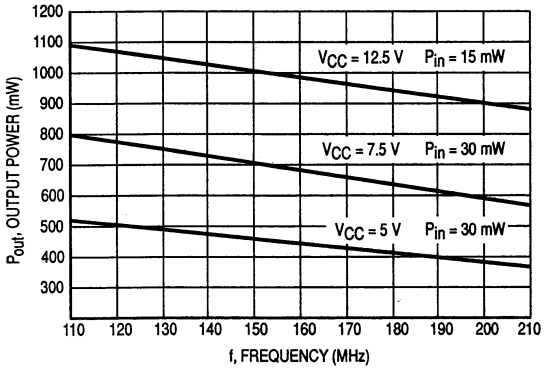


Figure 5. Output Power versus Frequency

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V_{CE} (Volts)	I_C (mA)	f (MHz)	S_{11}		S_{21}		S_{12}		S_{22}	
			$\|S_{11}\|$	$\angle\phi$	$\|S_{21}\|$	$\angle\phi$	$\|S_{12}\|$	$\angle\phi$	$\|S_{22}\|$	$\angle\phi$
5.0	5.0	50	0.82	−104	10.3	125	0.05	38	0.68	−34
		100	0.83	−141	6.1	103	0.06	26	0.51	−40
		200	0.81	−165	3.2	85	0.07	21	0.44	−46
		500	0.80	169	1.3	57	0.07	32	0.49	−73
		750	0.79	156	0.8	42	0.08	49	0.58	−94
		1000	0.76	144	0.6	30	0.11	61	0.65	−114
	25	50	0.77	−151	19	107	0.02	36	0.35	−75
		100	0.79	−168	9.9	94	0.03	37	0.21	−87
		200	0.79	−180	5.0	82	0.04	49	0.16	−97
		500	0.78	163	2.0	61	0.07	62	0.22	−106
		750	0.77	152	1.3	48	0.10	66	0.31	−115
		1000	0.74	141	0.9	36	0.13	66	0.37	−127
	50	50	0.77	−163	21.1	103	0.02	37	0.29	−98
		100	0.79	−174	10.7	92	0.02	50	0.19	−119
		200	0.79	177	5.4	82	0.03	62	0.16	−134
		500	0.78	162	2.2	62	0.07	67	0.20	−131
		750	0.77	151	1.4	50	0.10	69	0.26	−130
		1000	0.74	140	1.1	38	0.13	67	0.32	−139
12	5.0	50	0.83	−97	11	129	0.04	46	0.75	−26
		100	0.82	−135	6.8	107	0.05	29	0.61	−29
		200	0.81	−162	3.6	88	0.05	24	0.54	−34
		500	0.79	171	1.4	60	0.06	37	0.47	−57
		750	0.78	157	0.9	44	0.07	55	0.64	−76
		1000	0.75	145	0.7	32	0.09	68	0.70	−95
	25	50	0.73	−143	22.1	111	0.02	38	0.43	−52
		100	0.76	−164	11.7	96	0.02	39	0.29	−52
		200	0.77	−177	6.0	84	0.03	48	0.22	−53
		500	0.76	165	2.4	63	0.06	64	0.27	−69
		750	0.75	154	1.6	49	0.08	67	0.35	−84
		1000	0.72	143	1.1	38	0.11	69	0.42	−98
	50	50	0.73	−156	25.5	106	0.02	41	0.32	−67
		100	0.75	−171	13.1	94	0.02	49	0.20	−69
		200	0.76	59	6.6	83	0.03	60	0.15	−71
		500	0.75	164	2.6	64	0.06	69	0.20	−81
		750	0.74	153	1.7	51	0.09	70	0.27	−92
		1000	0.71	142	1.2	38	0.12	70	0.34	−104

Table 1. Common Emitter S-Parameters

Freq. (MHz)	P_{in} (mW)	P_{out} (mW)	V_{CC} (Volts)	Z_{in} (Ohms)	Z_{OL}^* (Ohms)
136	15	—	12.5	6.2 – j11.6	—
175	15	—	12.5	4.6 – j10.4	—
136	—	1000	12.5	—	47.7 + j41.7
175	—	1000	12.5	—	47.4 – j34.4
136	30	—	7.5	5.65 – j12.6	—
175	30	—	7.5	6.25 – j12.2	—
136	—	650	7.5	—	27.6 – j32.4
175	—	650	7.5	—	27.9 – j27.6
136	30	—	5.0	6.1 – j13.3	—
175	30	—	5.0	5.9 – j12.22	—
136	—	450	5.0	—	24.8 – j22.8
175	—	450	5.0	—	28.3 – j29.3

Z_{OL}^* = Conjugate of optimum load impedance into which the device operates at a gain output power, voltage and frequency.

Table 2. Series Input/Output Impedances

MRFQ17

The RF Line
NPN Silicon High-Frequency Transistor

. . . designed for amplifier, oscillator or frequency multiplier applications in industrial equipment. Suitable for use as a Class A, B or C output driver or pre-driver stages in VHF and UHF.

- Low Cost SORF Plastic Surface Mount Package
- Guaranteed RF Specification — $|S_{21}|^2$
- S-Parameter Characterization
- Tape and Reel Packaging Options Available

I_C = 300 mA
SOURCE MOUNT
HIGH-FREQUENCY
TRANSISTOR
NPN SILICON

CASE 751, STYLE 1
(SO-8)

2

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	25	V
Collector-Base Voltage	V_{CBO}	40	V
Emitter-Base Voltage	V_{EBO}	2.0	V
Collector Current — Continuous	I_C	300	mA
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation @ T_A = 25°C Derate above 25°C	P_D	1.0 8.0	Watt mW/°C
Storage Temperature	T_{stg}	150	°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	125	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage (I_C = 10 mA)	$V_{(BR)CEO}$	25	—	—	V
Collector-Base Breakdown Voltage (I_C = 100 μA)	$V_{(BR)CBO}$	40	—	—	V
Emitter-Base Breakdown Voltage (I_E = 100 μA)	$V_{(BR)EBO}$	2.0	—	—	V
Collector Cutoff Current (V_{CB} = 20 V)	I_{CBO}	—	—	1.0	μA
Emitter Cutoff Current (V_{EB} = 1.0 V)	I_{CEO}	—	—	1.0	μA

(continued)

ELECTRICAL CHARACTERISTICS — continued (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (I_C = 50 mA, V_{CE} = 5.0 V) (I_C = 150 mA, V_{CE} = 5.0 V)	h_{FE}	 25 25	 — —	 200 200	—
Collector-Emitter Saturation Voltage (I_C = 100 mA, I_B = 10 mA)	$V_{CE(sat)}$	—	—	0.5	V
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain — Bandwidth Product (I_C = 50 mA, V_{CE} = 12.5 V, f = 500 MHz)	f_T	—	2250	—	MHz
Insertion Gain (V_{CE} = 12.5 V, I_C = 50 mA, f = 500 MHz)	$\|S_{21}\|^2$	10	12.2	—	dB

V_{CE} (Volts)	I_C (mA)	f (MHz)	S_{11}		S_{21}		S_{12}		S_{22}	
			$\|S_{11}\|$	∠ϕ	$\|S_{21}\|$	∠ϕ	$\|S_{12}\|$	∠ϕ	$\|S_{22}\|$	∠ϕ
12.5	50	10	0.32	−72	38.2	165	0.005	47	0.97	−13
		20	0.36	−103	37.8	151	0.007	48	0.88	−23
		50	0.60	−139	33.0	124	0.013	40	0.62	−42
		75	0.66	−152	25.0	112	0.014	36	0.49	−47
		100	0.69	−159	19.6	105	0.016	38	0.43	−49
		200	0.72	−174	10.3	91	0.021	47	0.32	−51
		500	0.72	168	4.10	68	0.040	65	0.37	−70
		750	0.70	157	2.80	57	0.059	72	0.43	−83
		1000	0.69	146	2.10	45	0.081	76	0.47	−95

Table 1. Common Emitter S-Parameters